IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Application No.: 10/828,596

Confirmation No.: 5520

Group Art Unit: 2812

Filed: April 21, 2004

For: METHODS OF FORMING METAL THIN FILMS, LANTHANUM OXIDE FILMS,

AND HIGH DIELECTRIC FILMS FOR SEMICONDUCTOR DEVICES USING

ATOMIC LAYER DEPOSITION

November 15, 2004

Mail Stop Missing Parts Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

PETITION AND FEE FOR EXTENSION OF TIME (37 C.F.R. § 1.136(a))

1.	This is a petition for an extension of time for a total period of three (3) month(s) to
respon	d to the Notice to File Missing Parts of Application-Filing Date Granted (PTO-1533)
dated J	July 1, 2004.

dated	July 1, 2004.		
2.	A response in connec	tion with the matter for which	this extension is requested:
	⊠ is:	filed herewith.	
	ha	s been filed.	
3.	Applicant:		
	Claims sn	nall entity status. See 37 CFR	1.27.
	Does not	claim small entity status.	
4.	Calculation of extens	ion fee (37 C.F.R. § 1.17(a)-(a)	d)):
	Total Months	Fee For Other	Fee for
	Requested	Than Small Entity	Small Entity
_	_		

5.00
5.00
0.00
5.00
40.00

Fee Due \$ 980.00

11/18/2004 ZJUHAR1 00000008 10828596

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980.00 OP

∇	A short in trading the surrount of the feet is smallered
	A check including the amount of the fee is enclosed.
	Payment by credit card (Form PTO-2038) is enclosed.
\boxtimes	Charge Deposit Account No. 50-0220 for any additional extension and/or fee required or credit for any excess fee paid.
	Respectfully submitted, Shawna Cannon Lemon Registration No. 53,888

Myers Bigel Sibley & Sajovec, P.A.

P. O. Box 37428

Raleigh, North Carolina 27627 Telephone: (919) 854-1400 Facsimile: (919) 854-1401 Customer Number 20792

Certificate of Mailing under 37 CFR 1.8

I hereby certify that this correspondence is being deposited with the United States Postal Service with sufficient postage as first class mail in an envelope addressed to: Mail Stop MISSING PARTS, Commissioner for Patents, P.O. Box 1450, Alexandria VA 22313-1450 on November 15, 2004.

Susan E. Freedman

Date of Signature: November 15, 2004